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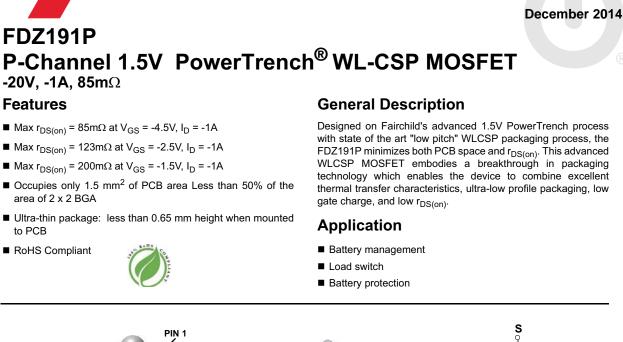


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		-20	V	
V _{GS}	Gate to Source Voltage		±8	V	
I _D	Drain Current -Continuous	(Note 1a)	-3		
	-Pulsed		-15	— A	
P _D	Power Dissipation	(Note 1a)	1.9		
	Power Dissipation	(Note 1b)	0.9		
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C	

Thermal Characteristics

FAIRCHILD

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	65	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1b)	133	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
1	FDZ191P	WL-CSP	7"	8mm	5000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = -250μA, V _{GS} = 0V	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		-12		mV/°0
IDSS	Zero Gate Voltage Drain Current	V _{DS} = -16V, V _{GS} = 0V			-1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 8V, V_{DS} = 0V$			±100	nA
On Chara	cteristics			·		
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = -250μA	-0.4	-0.6	-1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$, referenced to 25°C		2		mV/°C
r _{DS(on)}		V _{GS} = -4.5V, I _D = -1A		67	85	
		$V_{GS} = -2.5V, I_D = -1A$		85	123	
	Drain to Source On Resistance	$V_{GS} = -1.5V, I_D = -1A$		140	200	- mΩ
		$V_{GS} = -4.5V, I_D = -1A T_J = 125^{\circ}C$		87	123	
I _{D(on)}	On to State Drain Current	V _{GS} = -4.5V, V _{DS} = -5V	-10			Α
9 _{FS}	Forward Transconductance	$V_{DS} = -5V, I_{D} = -1A$		7		S
-	Characteristics					
C _{iss}	Input Capacitance			800		pF
C _{oss}	Output Capacitance	— V _{DS} = -10V, V _{GS} = 0V, f = 1MHz		155		pF
C _{rss}	Reverse Transfer Capacitance			90		pF
R _g	Gate Resistance	f = 1MHz		9		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			11	20	ns
t _r	Rise Time	$V_{DD} = -10V, I_D = -1A$		10	20	ns
t _{d(off)}	Turn-Off Delay Time	$-$ V _{GS} = -4.5V, R _{GEN} = 6 Ω		50	80	ns
t _f	Fall Time			30	48	ns
Q _{g(TOT)}	Total Gate Charge at 10V	$V_{GS} = 0V$ to 10V $V_{DD} = -10V$		9	13	nC
Q _{gs}	Gate to Source Gate Charge	I _D = -1A		1		nC
Q _{gd}	Gate to Drain "Miller" Charge			2		nC
Drain-Soເ	urce Diode Characteristics					
I _S	Maximum continuous Drain-Source Diode	e Forward Current			-1.1	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = -1.1A (Note 2)		-0.7	-1.2	V
t _{rr}	Reverse Recovery Time			21		ns
Q _{rr}	Reverse Recovery Charge	—— I _F = -1A, di/dt = 100A/μs		5		nC

Notes:
1: R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. The thermal resistance from the junction to the circuit board side of the solder ball, R_{0JB} is defined for reference. For R_{0JC} the thermal reference point for the case is defined as the top surface of the copper chip carrier. R_{0JC} and R_{0JB} are guaranteed by design while R_{0JA} is determined by the user's board design.



2: Pulse Test: Pulse Width < 300µs, Duty cycle < 2.0%.

Reverse Recovery Charge

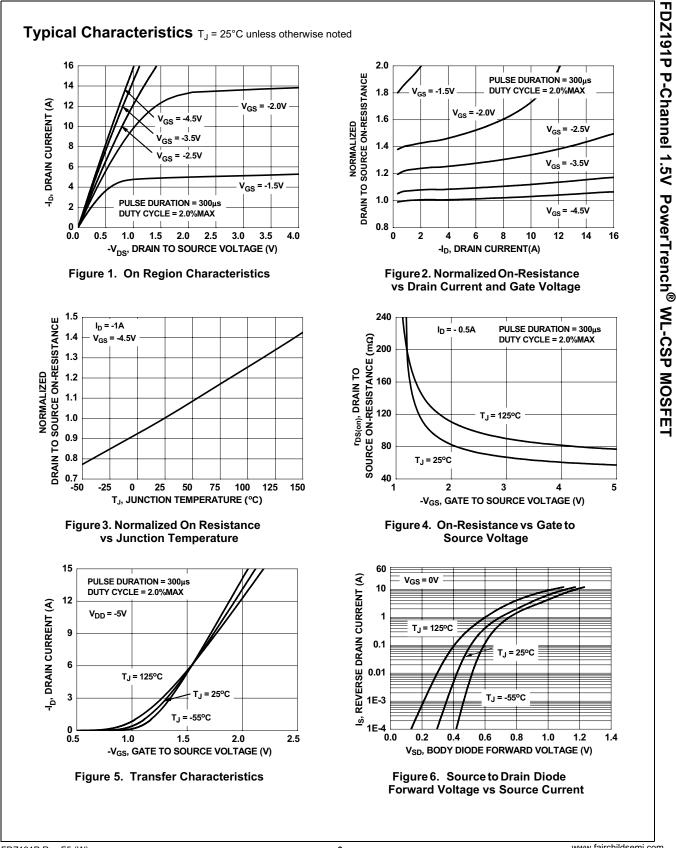
a. 65°C/W when mounted on a 1 in² pad of 2 oz copper,1.5" X 1.5" X 0.062" thick PCB



b. 133°C/W when mounted on a minimum pad of 2 oz copper

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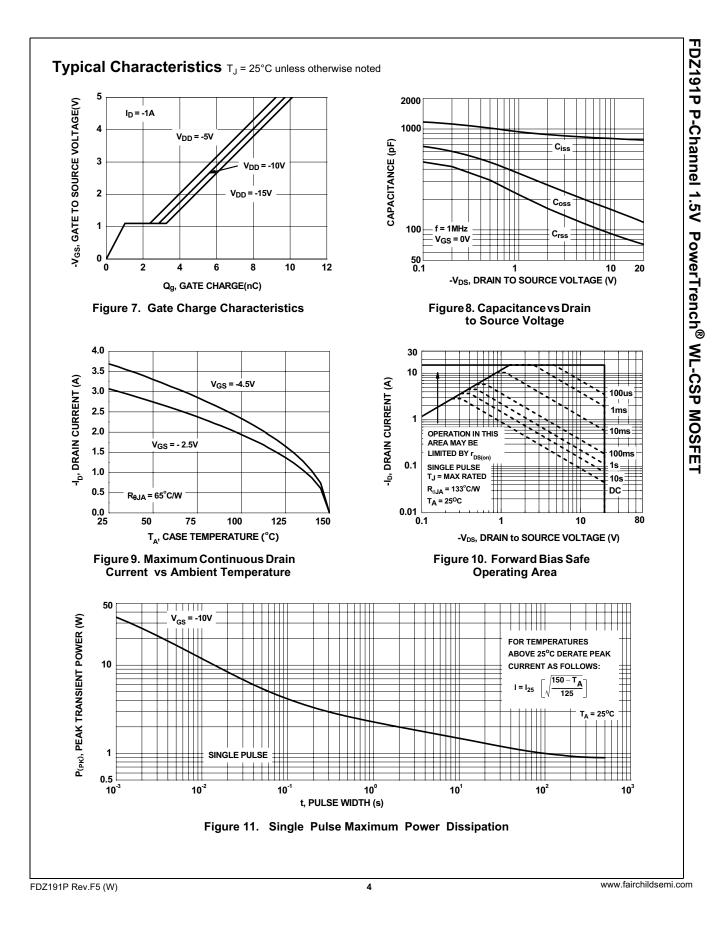
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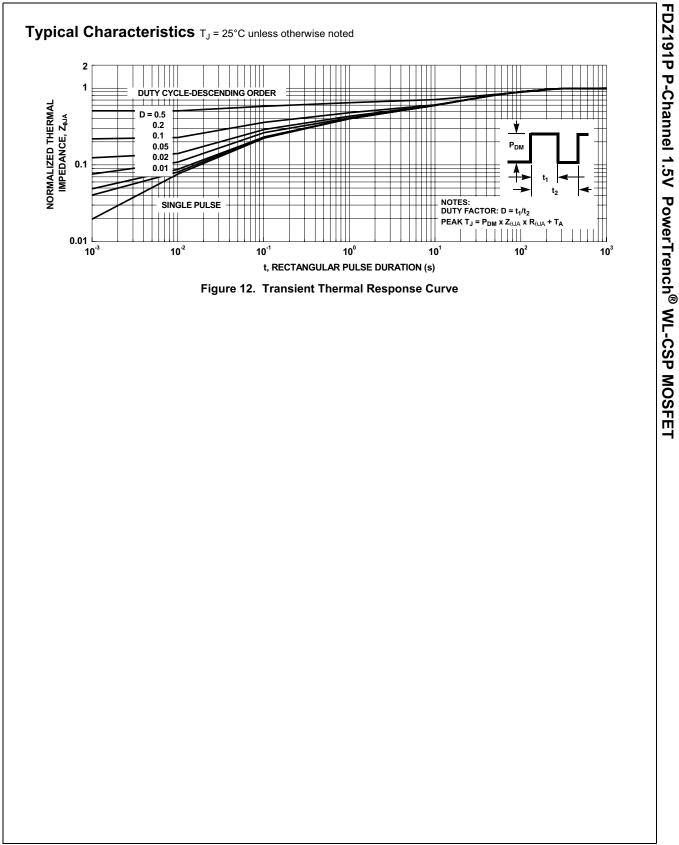


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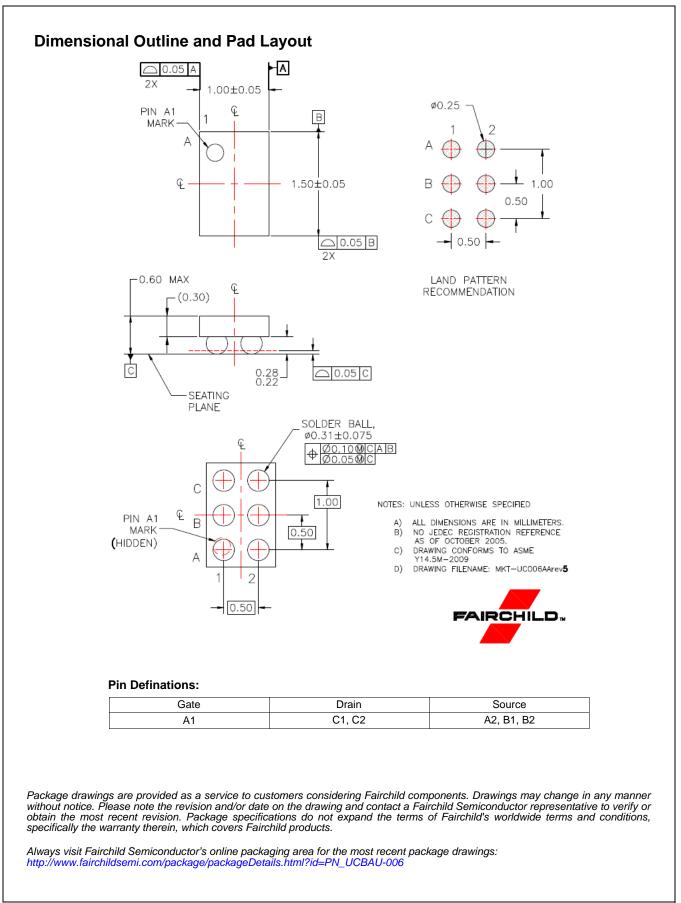
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FDZ191P P-Channel 1.5V PowerTrench[®] WL-CSP MOSFET

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